

# SANYO Semiconductors **DATA SHEET**

An ON Semiconductor Company

# STK681-300 — Thick-Film Hybrid IC Forward/Reverse Motor Driver

#### Overview

The STK681-300 is a hybrid IC for use in current control forward/reverse DC motor driver with brush.

## **Applications**

• Office photocopiers, printers, etc.

#### **Features**

- Allows forward, reverse, and brake operations in accordance with the external input signal.
- 2.9A startup output current and 5A peak brake output current.
- Incorporating a current detection resistor  $(0.10\Omega)$ , fixed current control is possible.
- Obviate the need to design for the dead time in order to turn off the upper- and lower drive devices when switching between the forward and reverse operation mode.

## **Specifications**

### Absolute maximum ratings at $Tc = 25^{\circ}C$

Parameter	Symbol	Conditions Ratings		unit
Maximum supply voltage 1	V <sub>CC</sub> 1 max	V <sub>CC</sub> 2=0V	52	V
Maximum supply voltage 2	V <sub>CC</sub> 2 max	No signal	-0.3 to +7.0	V
Input voltage	V <sub>IN</sub> max	Logic input pins	-0.3 to +7.0	V
Output current	I <sub>O</sub> max	V <sub>CC</sub> 2=5.0V, DC current	2.9	А
Brake current	I <sub>O</sub> B max	V <sub>CC</sub> 2=5.0V, square wave current, operating time 12ms (single pulse)	5	А
Allowable power dissipation	PdPK max	No heat sink	3.1	W
Operating substrate temperature	Tc max		105	°C
Junction temperature	Tj max		150	°C
Storage temperature	Tstg		-40 to +125	°C

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment (home appliances, AV equipment, communication device, office equipment, industrial equipment etc.). The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for applications outside the standard applications of our customer who is considering such use and/or outside the scope of our intended standard applications, please consult with us prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

## Allowable Operating Ranges at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	unit
Operating supply voltage 1	V <sub>CC</sub> 1	With signals applied	10 to 42	V
Operating supply voltage 2	V <sub>CC</sub> <sup>2</sup>	With signals applied	5±5%	V
Input voltage	V <sub>IN</sub>		0 to V <sub>CC</sub> 2	V
Output current 1	I <sub>O</sub> 1	V <sub>CC</sub> 2=5.0V, DC current, Tc≤70°C	2.9	Α
Output current 2	I <sub>O</sub> 2	V <sub>CC</sub> 2=5.0V, DC current, Tc=90°C	2.4	Α
Output current 3	I <sub>O</sub> 3	V <sub>CC</sub> 2=5.0V, DC current, Tc=105°C	2.1	Α
Brake current	IOB	$V_{CC}$ 2=5.0V, square wave current, operating time 1.3ms, $T_{c}$ =105°C	5	А

Refer to the graph for each conduction-period tolerance range for the output current and brake current.

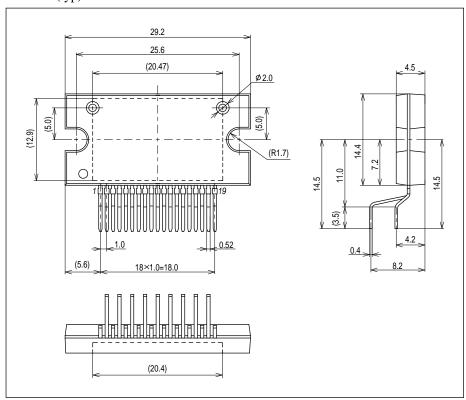
## **Electrical Characteristics** at Tc = 25°C, $V_{CC}1 = 24V$ , $V_{CC}2 = 5.0V$

Parameter	Symbol	Conditions m		typ	max	unit
V <sub>CC</sub> 2 supply current	Icco	Forward or reverse operation		1.7	4	mA
FET diode forward voltage	Vdf	If=1A (R <sub>L</sub> =23Ω)		1.0	1.6	V
Output saturation voltage 1	Vsat1	R <sub>L</sub> =23Ω, TR1, TR2		0.80	1.1	V
Output saturation voltage 2	Vsat2	$R_L$ =23 $\Omega$ , F1, F2+current detection resistance		0.34 0.48		٧
Output leak current	loL	TR1, TR2, F1, and F2 OFF operation			50	μΑ
Input high voltage 1	V <sub>IH</sub> 1	IN1, IN2 pins	4.0			V
Input high voltage 2	V <sub>IH</sub> 2	INH pin	2.5			V
Input low voltage	VIL	IN1, IN2, INH pins			0.6	V
Input current 1	I <sub>IH</sub> 1	IN1, IN2 pins, V <sub>IH</sub> 1=5V	0.10	0.20	0.40	mA
Input current 2	I <sub>IH</sub> 2	INH pin, V <sub>IH</sub> 2=5V	0.30	0.60	1.2	mA
Current set ting voltage	Vref1	Between pins Vref1 and S.P		0.29		V

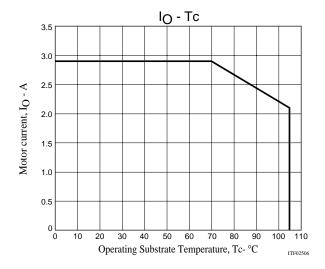
Note: A fixed-voltage power supply must be used.

# **Package Dimensions**

unit:mm (typ)

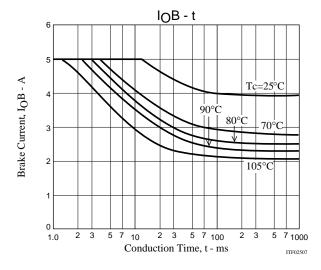


Derating Curve of Motor Current, IO. vs. STK681-300 Operating Board Temperature, Tc

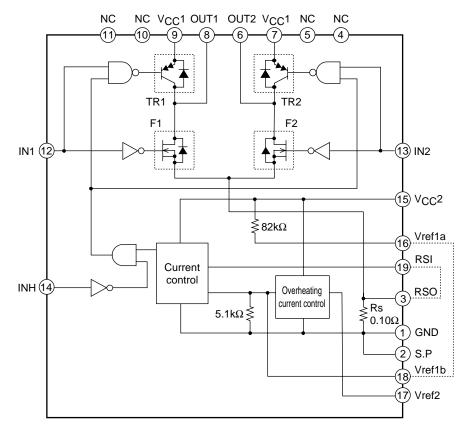


The range of DC operating current lies within the above derating curve in the  $V_{\rm CC}1$  allowable operating range. The above motor current  $I_{\rm O}$  is valid within the chopping operating range of  $V_{\rm CC}1$ =28V or lower. The above operating substrate temperature, Tc, is measured immediately when the motor is started. Since Tc fluctuates due to the ambient temperature, Ta, the motor current value, and continuous or intermittent operations of the motor current, always confirm this values using an actual set.

STK681-300 Allowable Brake Current Range

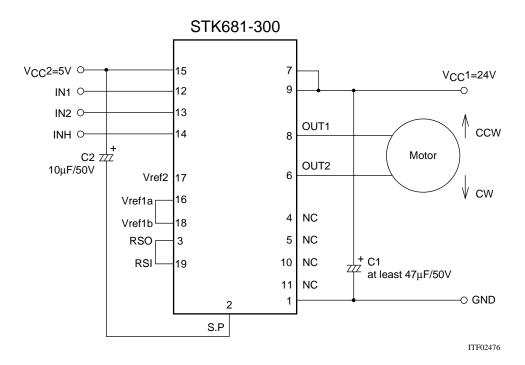


## **Internal Block Diagram**



ITF02477

## **Sample Application Circuit**



### STK681-300

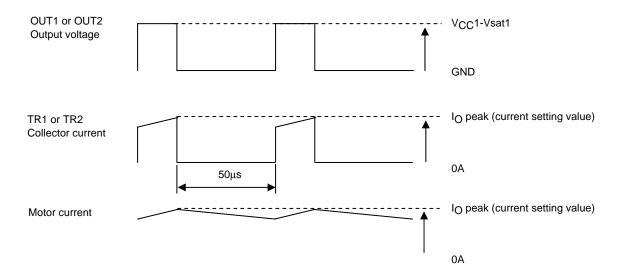
## Motor Drive Conditions (H: High-level input; L: Low-Level Input)

	IN1	IN2	INH	Remarks	
Stop 1 (standby)	Н	Н	H or L	When motor is not rotating	
Stop 2 (supply power turned off by input during	Н	Н	Н	Stop signal that is applied when the motor is	
motor rotation)	Н	L	Н	running and used to turn off power.	
	L	Н	Н		
Forward (CW)	н	L	L	No input signal is needed that turns off the	
Reverse (CCW)	L	Н	L	upper- and lower-side drive devices when switching the rotational direction.	
Brake	L	L	L or H	GND side MOSFET ON	

<sup>\*</sup> IN1=IN2=H and INH=L are prohibited during motor rotation.

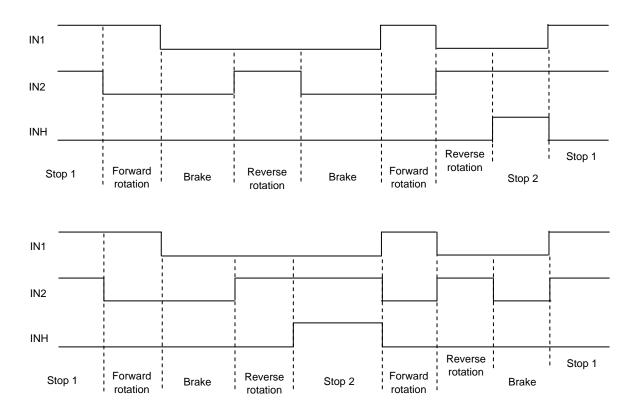
#### Notes

- (1) Be sure to set the capacitance of the power supply bypass capacitor, C1, so that the ripple current of the capacitor, which varies as motor current increases, falls within the allowed range.
- (2) Although the Vref2 pin is kept open, if connected to the GND or S.P pin, the overheating current control circuit ceases to function.
- (3) Fixed current chopping operations based on TR1 and TR2 are used for current control. The timing given below is used for OUT1 or OUT2 voltage output and for TR1 or TR2 collector current.



- (4) Do not connect the N.C pins shown in the internal block diagram or sample application circuit to a circuit pattern on the PCB.
- (5) This IC is not designed for use in an H-bridge driver for power supplies because the I/O response time of its GND side driving device, required when switching the motor rotational direction, is several scores of microseconds. It should be used only for DC motor drivers.

## (6) Sample Timing Diagram



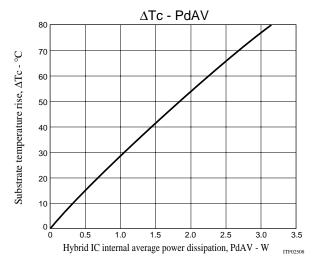
(7) Smoke Emission Precautions: There is a possibility of smoke emission if the hybrid IC is subjected to physical or electrical damage as the result of being used without compliance with the specifications.

## I/O Functions of Each Pin

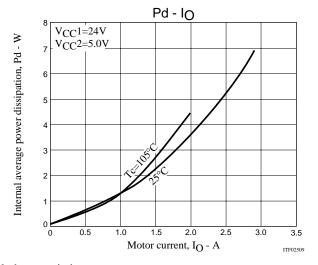
Pin Name	Pin No.	Function
IN1	12	Input pin for turning TR1 and F1 ON and OFF
		At high level, TR1: ON and F1: OFF; at low level TR1: OFF and F1: ON
IN2	13	Input pin for turning TR2 and F2 ON and OFF
		At high level, TR2: ON and F2: OFF; at low level, TR2: OFF and F2: ON
INH	14	Pin for turning TR1 and TR2 OFF; At high level TR1 and TR2: OFF
		This pin is usually low or open.
OUT1	8	This pin connects to the motor and outputs source/sync current depending on conditions at IN1 and IN2.
OUT2	6	This pin connects to the motor and outputs source/sync current depending on conditions at IN1 and IN2.
Vref1a	16	This pin is used for current setting for constant-current operation performed with the Vrefa and Vrefb pins
Vref1b	18	connected
		A voltage of 0.29V at Tc=25°C results for Vref1.
		0.29V is set by connecting $82k\Omega$ and $5.1k\Omega$ in series.
		Current detection resistance is Rs=0.10Ω. Set using I <sub>O</sub> peak=Vref1÷Rs.
Vref2	17	Be sure to usually leave this pin open.
		The overheating control circuit can be made to stop operating by connecting this pin to the GND or S.P pin.
S.P	2	Vref1 voltage can be lowered by connecting a resistor between the Vref1 and S.P pins.
RSO	3	This pin is used to monitor the voltage across the current sensing resistor, Rs. Must be connected to the RSI
		pin.
RSI	19	This pin is connected to the RSO pin and serves as an input to the circuit that compares the input with Vref1.

## **Technical Information**

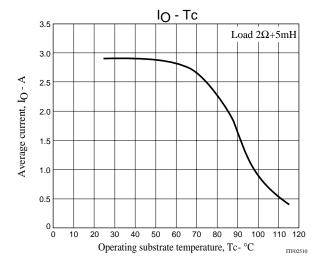
(1) Substrate temperature rise ,  $\Delta Tc$  (no heat sink) - Internal average power dissipation, PdAV



(2) Internal average power dissipation, Pd, in the DC current-motor current, IQ, characteristics (typ values for Pd)

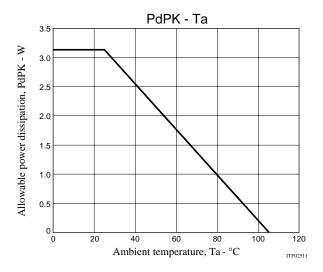


(3) Overheating current control characteristics

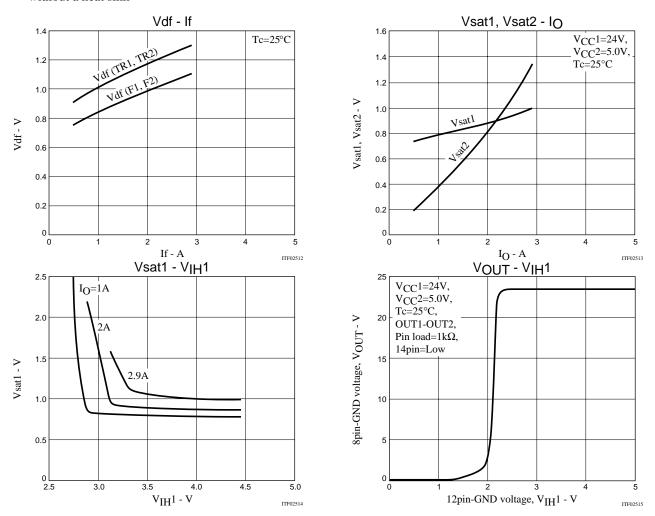


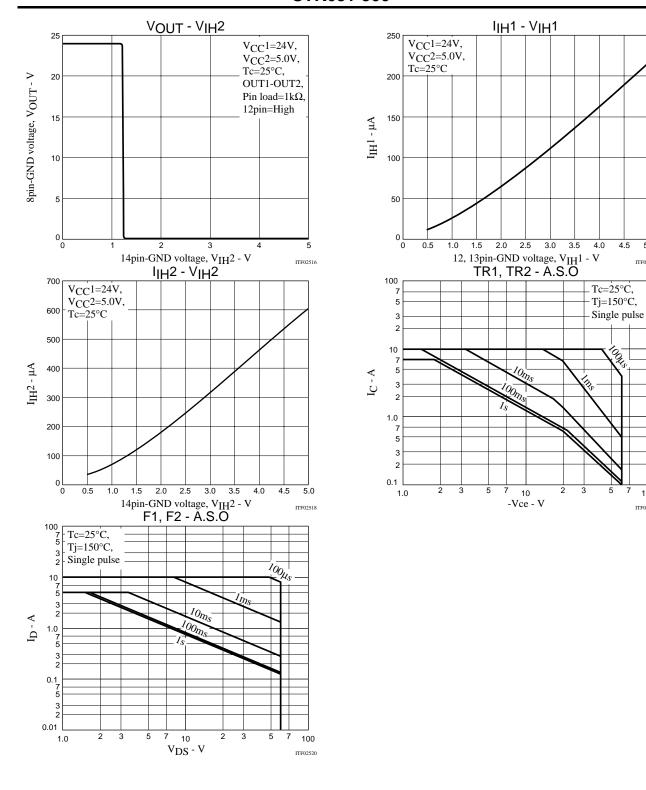
Overheating current control functions to prevent driver failure if a motor lock malfunction occurs.

(4) Derating curve of the package power dissipation, PdPK, against the ambient temperature, Ta



The package power dissipation, PdPK, refers to the internal average power dissipation, Pd, permissible if used without a heat sink



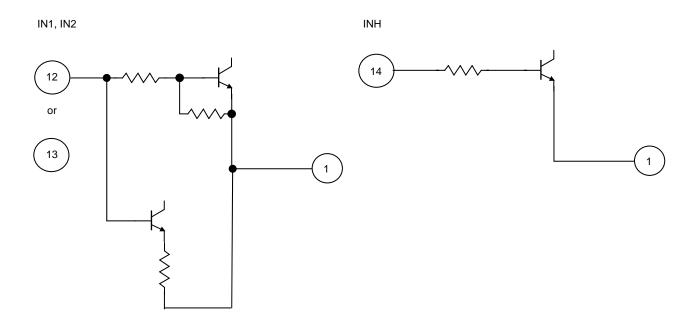


4.5

Tooks

ITF02517

## **Input Pin Configurations**



- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of June, 2011. Specifications and information herein are subject to change without notice.